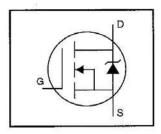
# International Rectifier

# IRFP440PbF

#### HEXFET® Power MOSFET

- Dynamic dv/dt Rating
- · Repetitive Avalanche Rated
- Isolated Central Mounting Hole
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Lead-Free

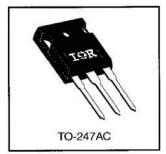


$$V_{DSS} = 500V$$
 $R_{DS(on)} = 0.85\Omega$ 
 $I_D = 8.8A$ 

#### Description

Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-247 package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220 devices. The TO-247 is similar but superior to the earlier TO-218 package because of its isolated mounting hole. It also provides greater creepage distance between pins to meet the requirements of most safety specifications.



#### **Absolute Maximum Ratings**

	Parameter	Max.	Units		
I <sub>D</sub> @ T <sub>C</sub> = 25°C	Continuous Drain Current, V <sub>GS</sub> @ 10 V	8.8			
I <sub>D</sub> @ T <sub>C</sub> = 100°C	Continuous Drain Current, VGS @ 10 V	5.6	A		
Іом	Pulsed Drain Current ①	35			
P <sub>D</sub> @ T <sub>C</sub> = 25°C	Power Dissipation	150	W		
	Linear Derating Factor	1.2	W/°C		
V <sub>GS</sub>	Gate-to-Source Voltage	±20	V		
Eas	Single Pulse Avalanche Energy ②	480	mJ		
I <sub>AR</sub>	Avalanche Current ①	8.8	A		
EAR	Repetitive Avalanche Energy ①	15	mJ		
dv/dt	Peak Diode Recovery dv/dt ③	3.5	V/ns		
T <sub>J</sub> T <sub>STG</sub>	Operating Junction and Storage Temperature Range	-55 to +150	°C		
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)			
	Mounting Torque, 6-32 or M3 screw	10 lbf•in (1.1 N•m)			

#### **Thermal Resistance**

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	Parameter	Min.	Тур.	Max.	Units	
Reuc	Junction-to-Case	R	_	0.83	3	
Recs	Case-to-Sink, Flat, Greased Surface		0.24		°C/W	
Beia	Junction-to-Ambient		_	40		

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#### Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Test Conditions	
V <sub>(BR)DSS</sub>	Drain-to-Source Breakdown Voltage	500		8-3	٧	V <sub>GS</sub> =0V, I <sub>D</sub> = 250μA	
ΔV <sub>(BR)DSS</sub> /ΔT <sub>J</sub>	Breakdown Voltage Temp. Coefficient		0.78	<u>3—</u> )5	V/°C	Reference to 25°C, I <sub>D</sub> = 1mA	
Ros(on)	Static Drain-to-Source On-Resistance		====	0.85	Ω	V <sub>GS</sub> =10V, I <sub>D</sub> =5.3A ④	
V <sub>GS(th)</sub>	Gate Threshold Voltage	2.0	=	4.0	٧	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> = 250μA	
9fs	Forward Transconductance	5.3		-	S	V <sub>DS</sub> =50V, I <sub>D</sub> =5.3A ④	
¥	Drain to Source Leakage Current	_	_	25	μА	V <sub>DS</sub> =500V, V <sub>GS</sub> =0V	
loss	Drain-to-Source Leakage Current			250	μΑ	V <sub>DS</sub> =400V, V <sub>GS</sub> =0V, T <sub>J</sub> =125°C	
1	Gate-to-Source Forward Leakage	-	_	100	nA	V <sub>GS</sub> =20V	
lgss	Gate-to-Source Reverse Leakage		-	-100	11/4	V <sub>GS</sub> =-20V	
Qg	Total Gate Charge	-		63		I <sub>D</sub> =8.0A	
Q <sub>gs</sub>	Gate-to-Source Charge	_		11	nC	V <sub>DS</sub> =400V	
Q <sub>gd</sub>	Gate-to-Drain ("Miller") Charge	_	-	30		V <sub>GS</sub> =10V See Fig. 6 and 13 @	
t <sub>d(cn)</sub>	Turn-On Delay Time	-	14	-		V <sub>DD</sub> =250V	
tr	Rise Time		23	-	ns	I <sub>D</sub> =8.0A	
t <sub>d(off)</sub>	Turn-Off Delay Time	-	49	-		R <sub>G</sub> =9.1Ω	
tr	Fall Time	-	20	5-18		R <sub>D</sub> =31Ω See Figure 10 @	
L <sub>D</sub>	Internal Drain Inductance	-	5.0		nH	Between lead, 6 mm (0.25in.)	
Ls	Internal Source Inductance	-	13		101	from package and center of die contact	
Ciss	Input Capacitance	] -	1300	<del></del> 8		V <sub>GS</sub> =0V	
Coss	Output Capacitance	_	310	-	pF	V <sub>DS</sub> = 25V	
Crss	Reverse Transfer Capacitance	_	120	-		f=1.0MHz See Figure 5	

#### Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Test Conditions
ls	Continuous Source Current (Body Diode)	_	_	8.8	A	MOSFET symbol showing the
Ism	Pulsed Source Current (Body Diode) ①	_	-	35		integral reverse p-n junction diode.
V <sub>SD</sub>	Diode Forward Voltage		_	2.0	V	T <sub>J</sub> =25°C, I <sub>S</sub> =8.8A, V <sub>GS</sub> =0V @
trr	Reverse Recovery Time		460	970	ns	T <sub>J</sub> =25°C, I <sub>F</sub> =8.0A
Qrr	Reverse Recovery Charge	=	3.5	7.6	μC	di/dt=100A/μs ④
ton	Forward Turn-On Time	Intrinsic turn-on time is neglegible (turn-on is dominated by Ls+Lb)				

#### Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature (See Figure 11)
- ③ I<sub>SD</sub>≤8.8A, di/dt≤100A/μs, V<sub>DD</sub>≤V(BR)DSS, T<sub>J</sub>≤150°C
- $V_{DD}$ =50V, starting T<sub>J</sub>=25°C, L=11mH R<sub>G</sub>=25Ω, I<sub>AS</sub>=8.8A (See Figure 12)
- 4 Pulse width  $\leq$  300  $\mu$ s; duty cycle  $\leq$ 2%.

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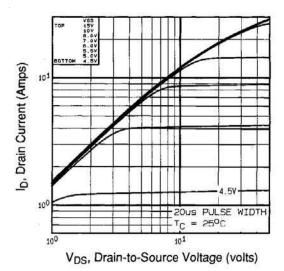


Fig 1. Typical Output Characteristics, Tc=25°C

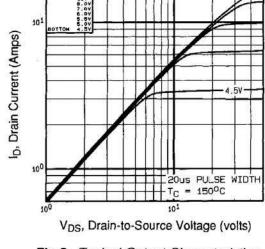


Fig 2. Typical Output Characteristics, Tc=150°C

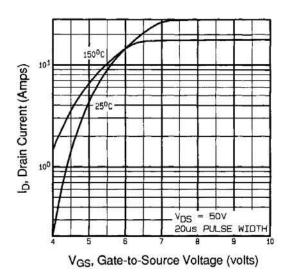


Fig 3. Typical Transfer Characteristics

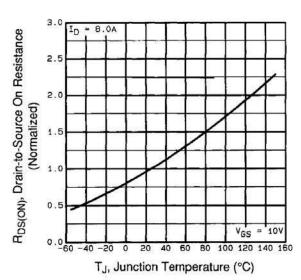


Fig 4. Normalized On-Resistance Vs. Temperature

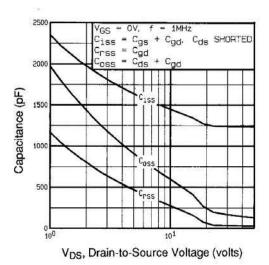


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

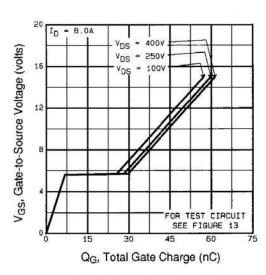


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

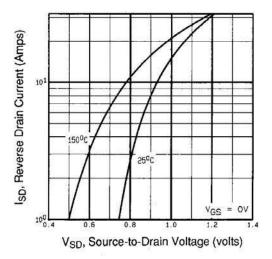


Fig 7. Typical Source-Drain Diode Forward Voltage

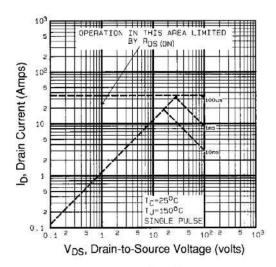


Fig 8. Maximum Safe Operating Area

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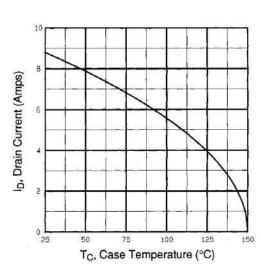


Fig 9. Maximum Drain Current Vs. Case Temperature

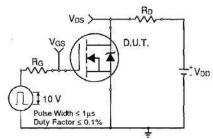


Fig 10a. Switching Time Test Circuit

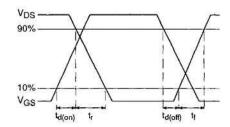


Fig 10b. Switching Time Waveforms

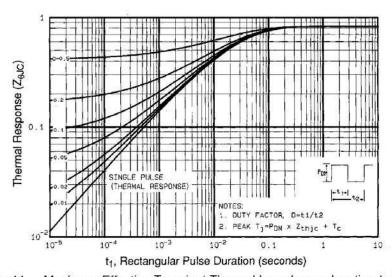


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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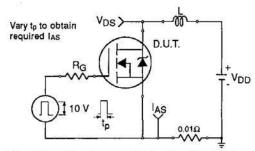


Fig 12a. Unclamped Inductive Test Circuit

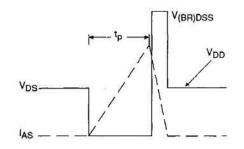


Fig 12b. Unclamped Inductive Waveforms

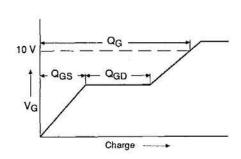


Fig 13a. Basic Gate Charge Waveform

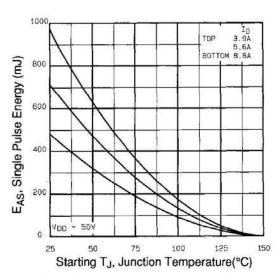


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

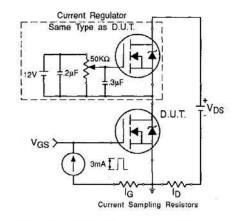
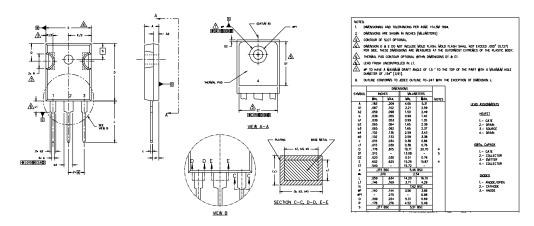


Fig 13b. Gate Charge Test Circuit

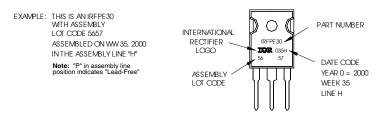
Appendix A: Figure 14, Peak Diode Recovery dv/dt Test Circuit - See page 1505

## TO-247AC Package Outline

Dimensions are shown in millimeters (inches)



## TO-247AC Part Marking Information



Data and specifications subject to change without notice.



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